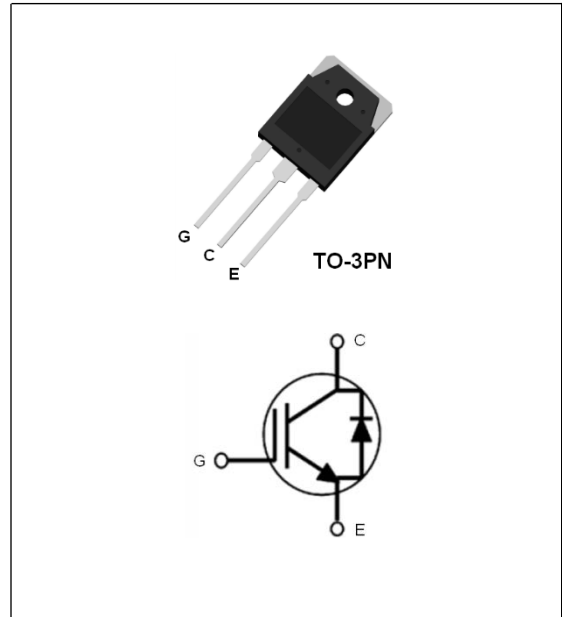


600V 40A FieldStop Trench IGBT

Description

The device is designed by advanced FieldStop Trench technology process. This IGBT offer low $V_{CE(sat)}$, high speed switching performance and excellent quality for application such as PFC, UPS, Welder, PV Inverter and other switching applications.



Features

- FieldStop Trench Technology, Positive temperature coefficient
- $V_{CE(sat)}=2.30V @ I_C=40A$
- $t_{rr}=46ns$ (typ.)
- High Speed Switching & Low Power Loss
- High Input Impedance

Applications

- PFC, UPS, Welder, PV Inverter

Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit	
V_{CES}	Collector to Emitter Voltage	600	V	
V_{GES}	Gate to Emitter Voltage	± 20	V	
I_C	Collector Current	$T_C=25^\circ C$	80	A
		$T_C=100^\circ C$	40	A
I_{CM}	Pulsed Collector Current	120	A	
I_F	Diode Continuous Forward Current	$T_C=100^\circ C$	20	A
I_{FM}	Diode Maximum Forward Current	60	A	
P_D	Maximum Power Dissipation	$T_C=25^\circ C$	258	W
		$T_C=100^\circ C$	129	W
T_J	Operating Junction Temperature Range	-40~+175	$^\circ C$	
T_{STG}	Storage Temperature Range	-55~+150	$^\circ C$	

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$ (IGBT)	Thermal Resistance, Junction to case for IGBT	0.58	$^\circ C/W$
$R_{th(J-C)}$ (Diode)	Thermal Resistance, Junction to case for Diode	1.8	$^\circ C/W$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	40	$^\circ C/W$

Electrical Characteristics of IGBT @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	Collector to Emitter Breakdown Voltage	$V_{GE}=0V, I_C=250\mu A$	600	-	-	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=40A, V_{GE}=15V$	-	2.30	2.7	V
		$I_C=40A, V_{GE}=15V, T_C=150\text{ }^\circ\text{C}$	-	2.60	-	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE}=V_{GE}, I_C=250\mu A$	4.0	5.1	6.0	V
I_{CES}	Zero Gate Voltage Collector Current	$V_{CE}=V_{CES}, V_{GE}=0V$	-	-	1	μA
I_{GES}	Gate to Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V$	-	-	± 250	nA

Electrical Characteristics of Diode @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=20A$	-	1.49	1.70	V
		$I_F=20A, T_C=150\text{ }^\circ\text{C}$	-	1.37	-	V
t_{rr}	Diode Reverse Recovery Time	$I_F=20A, di/dt=-200A/\mu s$	-	46	-	ns
I_{rr}	Diode Peak Reverse Recovery Current		-	6.0	-	A
Q_{rr}	Diode Reverse Recovery Charge		-	105	-	nC

Switching Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit	
$t_{d(on)}$	Turn-on Delay Time	$I_C=40A, V_{CC}=400V, V_{GE}=15V, R_G=14\Omega, \text{Inductive Load}, T_C=25\text{ }^\circ\text{C}$	-	25.0	-	ns	
t_r	Rising Time		-	27.1	-	ns	
$t_{d(off)}$	Turn-off Delay Time		-	90.1	-	ns	
t_f	Falling Time		-	10.0	-	ns	
E_{on}	Turn-on Switching Loss		-	1.29	-	mJ	
E_{off}	Turn-off Switching Loss		-	0.49	-	mJ	
E_{ts}	Total Switching Loss		-	1.78	-	mJ	
$t_{d(on)}$	Turn-on Delay Time		$I_C=40A, V_{CC}=400V, V_{GE}=15V, R_G=14\Omega, \text{Inductive Load}, T_C=125\text{ }^\circ\text{C}$	-	26.8	-	ns
t_r	Rising Time			-	31.0	-	ns
$t_{d(off)}$	Turn-off Delay Time			-	96.9	-	ns
t_f	Falling Time	-		22.0	-	ns	
E_{on}	Turn-on Switching Loss	-		1.71	-	mJ	
E_{off}	Turn-off Switching Loss	-		0.52	-	mJ	
E_{ts}	Total Switching Loss	-		2.23	-	mJ	
C_{ies}	Input Capacitance	$V_{GE}=0V, V_{CE}=25V, f=1.0MHz$		-	1685	-	pF
C_{res}	Reverse Transfer Capacitance			-	74	-	pF
C_{oes}	Output Capacitance			-	48	-	pF
Q_g	Total Gate Charge	$I_C=40A, V_{CE}=400V, V_{GE}=15V$	-	161	-	nC	
Q_{ge}	Gate to Emitter Charge		-	40	-	nC	
Q_{gc}	Gate to Collector Charge		-	48	-	nC	
tsc	Short Circuit With stand Time		$V_{CC}=400V, V_{GE}=15V$	-	5	-	us

Typical Performance Characteristics

Fig. 1. Typical Output Characteristics

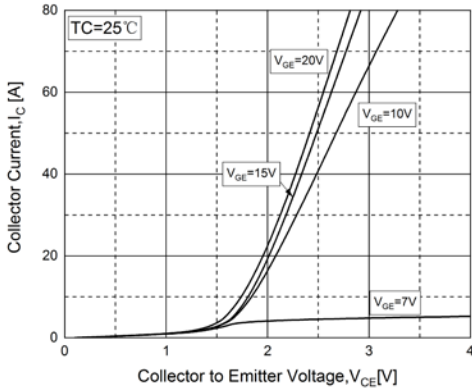


Fig. 2. Typical Saturation Voltage Characteristics

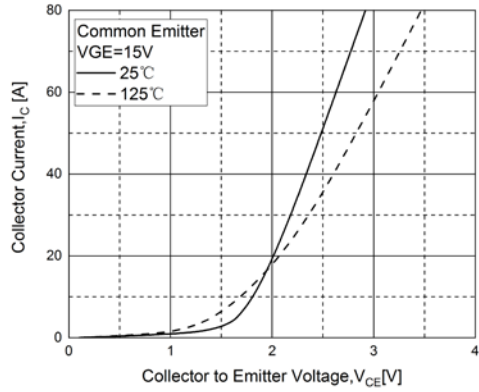


Fig. 3. Typical Saturation Voltage vs. T_C

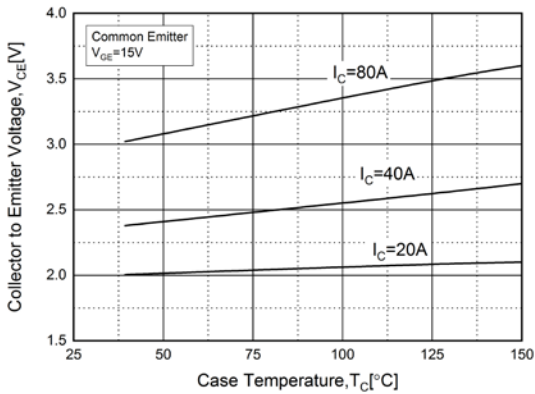


Fig. 4. Diode Forward Characteristics

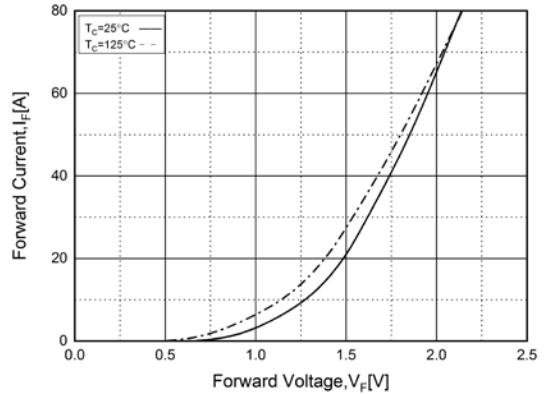


Fig. 5. Typical Capacitance Characteristics

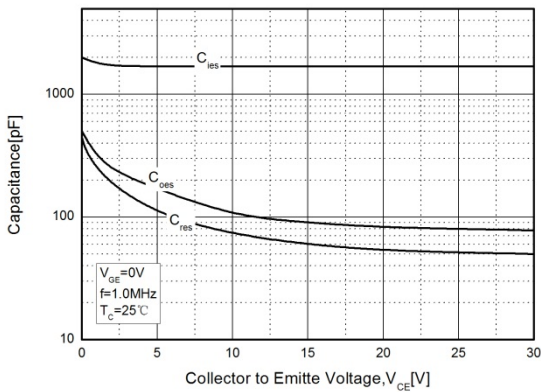
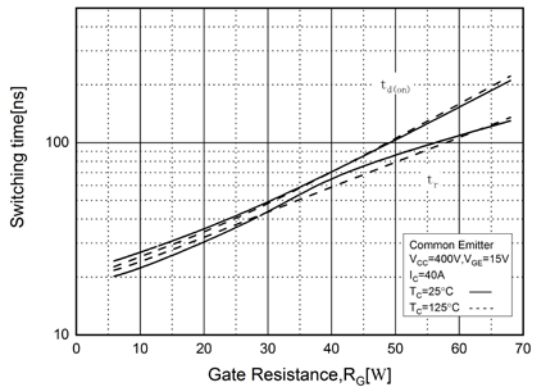


Fig. 6. Turn-on Characteristics vs. R_G



Typical Performance Characteristics

Fig. 7. Turn-off Characteristics vs. R_G

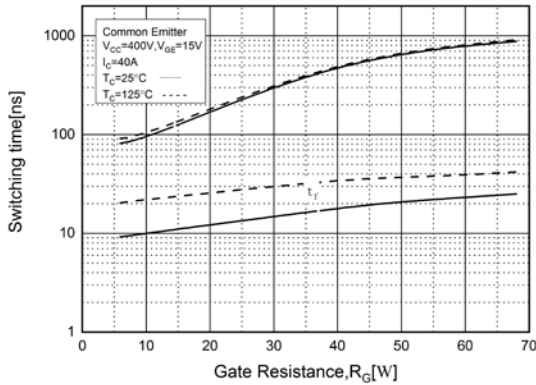


Fig. 8. Switching Loss vs. R_G

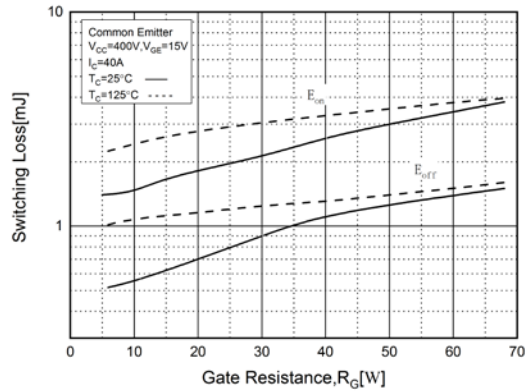


Fig. 9. Turn-on Characteristics vs. I_C

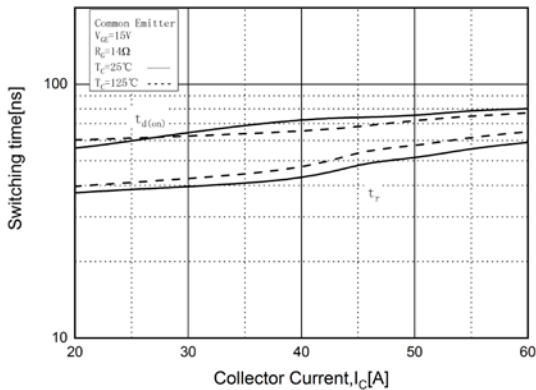


Fig. 10. Turn-off Characteristics vs. I_C

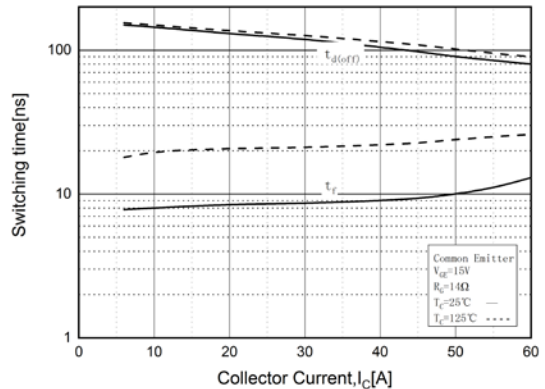
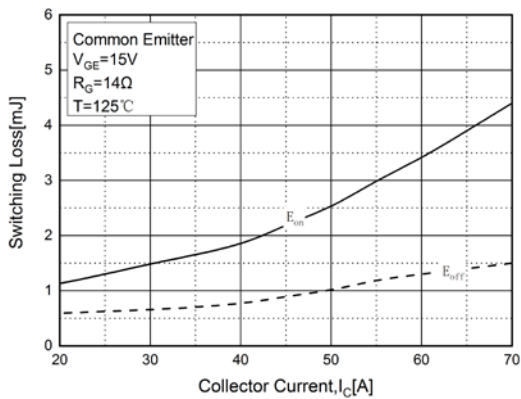


Fig. 11. Switching Loss vs. I_C



Package Dimensions

TO-3PN

(Dimensions in Millimeters)

